

DECLARATION FOR UNITED STATES PATENT APPLICATION, POWER OF ATTORNEY, DESIGNATION OF CORRESPONDENCE ADDRESS

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and that I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

SURFACE ACOUS	TIC WAVE FILTE	R WITH ATTENUAT	ON POLES	
he specification of wh] is attached hereto. X] was filed on Sep 10/668,379 and was amende	tember 24, 2003	[if app	licable].	, as Application Serial No.
he claims, as amended I acknowledge the comparished patentability as despolications, all maternational filing date of the content of the cont	ed by any amendmeduty to disclose to fined in Title 37, Contains a size of the disclose to the disclose to the disclose to disclose the	nents specifically referred the Patent and Trade Code of Federal Regulation became available be sunder Title 35, United or's certificate listed by design or inventor's	ed to herein. mark Office informatic llations, §1.56(a), incl etween the filing date of d States Code, §119 of below and have also	entified specification, including on known to me to be material luding for continuation-in-part of the prior application and the of any foreign application(s) for identified below any foreign filing date before that of the
Prior Foreign Applica Number 013353/2002			Date Filed anuary 22, 2002	Priority Claimed Yes No No
				ted States application(s) listed
Application Serial No. 06/441,354		Filing Date January 22, 200	3	Status
I hereby appoint to States Patent and Tra Jr. (Reg. No. 38,075 Street N.W. Suite 5	ademark Office co i), Phillip G. Avru 00, Washington, I o RABIN & BERDO	nnected therewith: Ste uch (Reg. No. 46, 07 D.C. 20005, Telephone	ven M. Rabin (Reg. N ′6) and Allen Wood (e: (202) 371-8976; F	sact all business in the United No. 29,102), Robert H. Berdo, Reg. No. 28,134), 1101 14th ax: (202) 408-0924. Address Washington, D.C. 20005.

23995

23995

Patent Trademark Office

I hereby authorize the U.S. attorneys named herein to accept and follow instructions from the undersigned's assignee, if any, and/or, if the undersigned is not a resident of the United States, the undersigned's domestic attorney, patent attorney, patent agent, or patent representative as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and the undersigned. In the event of a change in the person(s) from whom instructions may be taken, the U.S. attorneys named herein will be so notified by the undersigned.

DECLARATION FOR UNITED STATES PATENT APPLICATION, POWER OF ATTORNEY, DESIGNATION OF CORRESPONDENCE ADDRESS Page 2 of 2

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

validity of the approximation and pro-	
Signature: Kaznulige Projecti	Date: November 16, 2004
First Inventor: Kazushige NOGUCHI	
Citizenship: Japan	
Residence and Post Office Address: c/o Oki	Electric Industry Co., Ltd. oranomon 1-chome, Minato-ku, Tokyo, Japan
Signature:	Date:
Second Inventor: Satoshi TERADA	
Citizenship: Japan	
Residence and Post Office Address: 5-18-36	Konandai Konan-ku Yokohama-shi awa 234-0054 Japan
Signature: Wazoru Ohawhi	Date: <u>October</u> 30, 2004
Third Inventor: Wataru OHASHI	
Citizenship: Japan	
Residence and Post Office Address: c/o Oki 7-12, To	Electric Industry Co., Ltd. oranomon 1-chome, Minato-ku, Tokyo, Japan
Signature: Januahayu Harr	razaki Date: November 4, 2004
Fourth Inventor: Tomokazu KOMAZAKI	
Citizenship: Japan	The second secon
Residence and Post Office Address: c/o Oki	Technocollage Inc.
5-1. Na	ıka-cho, Hachiouji-shi, Tokyo, Japan